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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Confirmation No.: 5627

Dylan YU, et al. Art Unit: 2814

Serial No.: 10/680,434 Examiner: Not yet assigned

Filed: October 8, 2003 Docket No.: 030109

For: METHOD AND STRUCTURE FOR A WAFER LEVEL PACKAGING

AMENDMENT

Mail Stop AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

February 28, 2005

Dear Sir:

In response to the Office Action dated December 9, 2004, (hereinafter "outstanding Action"), please reconsider the above-identified application based on the following amendments, which follow a revised format under 37 C.F.R. §1.121: